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## MAX14934–MAX14936

## Four-Channel, 5kV<sub>RMS</sub> Digital Isolators

### General Description

The MAX14934–MAX14936 are a family of four-channel, 5kV<sub>RMS</sub> digital isolators utilizing Maxim's proprietary process technology. For applications requiring 2.75kV<sub>RMS</sub> of isolation, see the MAX14930–MAX14932. The MAX14934–MAX14936 family transfers digital signals between circuits with different power domains at ambient temperatures up to +125°C.

The MAX14934–MAX14936 family offers all three possible unidirectional channel configurations to accommodate any four-channel design, including SPI, RS-232, RS-485, and large digital IO modules. For applications requiring bidirectional channels, such as I<sup>2</sup>C, refer to the MAX14937.

Devices are available with data rates from DC up to 1Mbps, 25Mbps, or 150Mbps. Each device is also available in either a default high or default low configuration. The default is the state an output goes to when its input is unpowered. See the [Product Selector Guide](#) and [Ordering Information](#) for the suffixes associated with each option.

Independent 1.71V to 5.5V supplies on each side of the isolator also make the devices suitable for use as level translators.

The MAX14934–MAX14936 are available in a 16-pin wide body (10.3mm x 7.5mm) SOIC package. All devices are rated for operation at ambient temperatures of -40°C to +125°C.

[Product Selector Guide](#) and [Ordering Information](#) appear at end of data sheet.

### Benefits and Features

- Robust Galvanic Isolation of Digital Signals
  - Withstands 5kV<sub>RMS</sub> for 60s (V<sub>ISO</sub>)
  - Continuously Withstands 848V<sub>RMS</sub> (V<sub>IOWM</sub>)
  - 1200V<sub>P</sub> Repetitive Peak Voltage (V<sub>IORM</sub>)
  - Withstands ±10kV Surge per IEC 61000-4-5
- Interfaces Directly with Most Micros and FPGAs
  - Accepts 1.71V to 5.5V Supplies
- Many Options Support Broad Applications
  - 3 Data Rates (1Mbps, 25Mbps, 150Mbps)
  - 3 Channel Direction Configuration
  - 2 Output Default States (High or Low)
- Low Power Consumption at High Data Rates
  - At 1.8V:
    - 2.5mA per Channel Typical at 1Mbps
    - 5.25mA per Channel Typical at 100Mbps
  - At 3.3V:
    - 2.6mA per Channel Typical at 1Mbps
    - 7.1mA per Channel Typical at 100Mbps

### Safety Regulatory Approvals

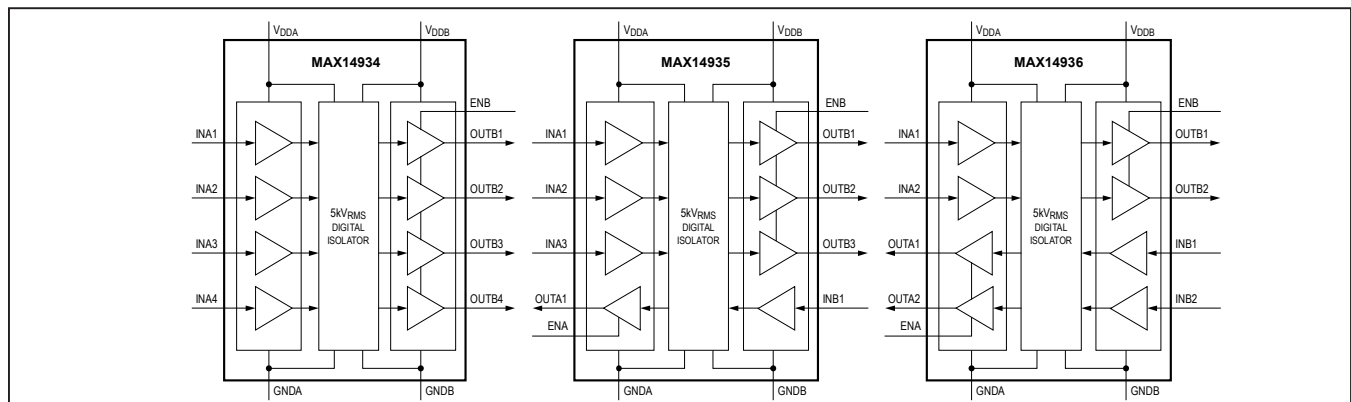
(see [Safety Regulatory Approvals](#))

- UL According to UL1577
- cUL According to CSA Bulletin 5A
- VDE 0884-11 Basic Insulation

### Applications

- Fieldbus Communications for Industrial Automation
- Isolated SPI, RS-232, RS-485/RS-422
- General Multichannel Isolation Applications
- Battery Management
- Medical Systems

### Functional Diagram



### Absolute Maximum Ratings

V <sub>DDA</sub> to GNDA, V <sub>DDB</sub> to GNDB .....	-0.3V to +6V	Continuous Power Dissipation (T <sub>A</sub> = +70°C)
INA <sub>-</sub> , ENA to GNDA .....	-0.3V to +6V	Wide SOIC (derate 14.1mW/°C above +70°C) .....
INB <sub>-</sub> , ENB to GNDB .....	-0.3V to +6V	Operating Temperature Range .....
OUTA <sub>-</sub> to GNDA .....	-0.3V to (V <sub>DDA</sub> + 0.3V)	Maximum Junction Temperature .....
OUTB <sub>-</sub> to GNDB .....	-0.3V to (V <sub>DDB</sub> + 0.3V)	Storage Temperature Range .....
Short-Circuit Duration		Lead Temperature (soldering, 10s) .....
(OUTA <sub>-</sub> to GNDA, OUTB <sub>-</sub> to GNDB) .....	Continuous	Soldering Temperature (reflow) .....

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### Package Information

<b>PACKAGE TYPE: 16 Wide SOIC</b>	
Package Code	W16M+8
Outline Number	<a href="#">21-0042</a>
Land Pattern Number	<a href="#">90-0107</a>
<b>THERMAL RESISTANCE, FOUR-LAYER BOARD</b>	
Junction to Ambient (θ <sub>JA</sub> )	71°C/W
Junction to Case (θ <sub>JC</sub> )	23°C/W

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to [www.maximintegrated.com/thermal-tutorial](http://www.maximintegrated.com/thermal-tutorial).

For the latest package outline information and land patterns (footprints), go to [www.maximintegrated.com/packages](http://www.maximintegrated.com/packages). Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

**DC Electrical Characteristics**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
<b>POWER SUPPLY</b>							
Operating Supply Voltage	V <sub>DDA</sub>	Relative to GNDA		1.71		5.5	V
	V <sub>DDB</sub>	Relative to GNDB		1.71		5.5	V
Undervoltage Lockout Threshold	V <sub>UVLO_</sub>	V <sub>DD_</sub> rising		1.45	1.58	1.71	V
Undervoltage Lockout Threshold Hysteresis	V <sub>UVLO_</sub> HYST				50		mV
Supply Current (MAX14934_)	I <sub>DDA</sub>	500kHz square wave	V <sub>DDA</sub> = 5V		1.2	1.9	mA
			V <sub>DDA</sub> = 3.3V		1.2	1.9	
			V <sub>DDA</sub> = 2.5V		1.2	1.9	
			V <sub>DDA</sub> = 1.8V		1.1	1.9	
		12.5MHz square wave (Note 2)	V <sub>DDA</sub> = 5V		2.1	2.7	
			V <sub>DDA</sub> = 3.3V		2	2.7	
			V <sub>DDA</sub> = 2.5V		2	2.7	
			V <sub>DDA</sub> = 1.8V		2	2.6	
		50MHz square wave (Note 2)	V <sub>DDA</sub> = 5V		5	6.6	
			V <sub>DDA</sub> = 3.3V		4.6	6.1	
			V <sub>DDA</sub> = 2.5V		4.5	6.0	
			V <sub>DDA</sub> = 1.8V		4.5	6.0	
	I <sub>DDB</sub>	500kHz square wave	V <sub>DDB</sub> = 5V		8.1	11.2	
			V <sub>DDB</sub> = 3.3V		7.9	11.1	
			V <sub>DDB</sub> = 2.5V		7.9	11.0	
			V <sub>DDB</sub> = 1.8V		7.7	10.8	
		12.5MHz square wave (Note 2)	V <sub>DDB</sub> = 5V		12.8	15.9	
			V <sub>DDB</sub> = 3.3V		11.1	14.2	
			V <sub>DDB</sub> = 2.5V		10.2	13.4	
			V <sub>DDB</sub> = 1.8V		9.4	12.4	
		50MHz square wave (Note 2)	V <sub>DDB</sub> = 5V		27.2	35.4	
			V <sub>DDB</sub> = 3.3V		21.7	27.8	
			V <sub>DDB</sub> = 2.5V		17.6	23.0	
			V <sub>DDB</sub> = 1.8V		14.4	18.9	

**DC Electrical Characteristics (continued)**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Current (MAX14935_)	I <sub>DDA</sub>	500kHz square wave	V <sub>DDA</sub> = 5V	3.4	5.3	mA
			V <sub>DDA</sub> = 3.3V	3.3	5.3	
			V <sub>DDA</sub> = 2.5V	3.3	5.3	
			V <sub>DDA</sub> = 1.8V	3.2	5.1	
		12.5MHz square wave (Note 2)	V <sub>DDA</sub> = 5V	5.6	7.1	
			V <sub>DDA</sub> = 3.3V	5	6.6	
			V <sub>DDA</sub> = 2.5V	4.7	6.4	
			V <sub>DDA</sub> = 1.8V	4.5	6.1	
		50MHz square wave (Note 2)	V <sub>DDA</sub> = 5V	12.4	16.0	
			V <sub>DDA</sub> = 3.3V	10.1	13.0	
			V <sub>DDA</sub> = 2.5V	9.1	11.6	
			V <sub>DDA</sub> = 1.8V	8.2	10.4	
	I <sub>DDB</sub>	500kHz square wave	V <sub>DDB</sub> = 5V	6.5	9.2	
			V <sub>DDB</sub> = 3.3V	6.4	9.1	
			V <sub>DDB</sub> = 2.5V	6.3	9.1	
			V <sub>DDB</sub> = 1.8V	6.2	8.9	
		12.5MHz square wave (Note 2)	V <sub>DDB</sub> = 5V	10.3	12.8	
			V <sub>DDB</sub> = 3.3V	8.9	11.6	
			V <sub>DDB</sub> = 2.5V	8.2	11.0	
			V <sub>DDB</sub> = 1.8V	7.6	10.3	
		50MHz square wave (Note 2)	V <sub>DDB</sub> = 5V	22.7	29.1	
			V <sub>DDB</sub> = 3.3V	17.7	23.0	
			V <sub>DDB</sub> = 2.5V	14.7	19.4	
			V <sub>DDB</sub> = 1.8V	11.9	15.9	

**DC Electrical Characteristics (continued)**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Supply Current (MAX14936_)	I <sub>DDA</sub>	500kHz square wave	V <sub>DDA</sub> = 5V	5.2	7.2	mA	
			V <sub>DDA</sub> = 3.3V	5.2	7.2		
			V <sub>DDA</sub> = 2.5V	5.2	7.2		
			V <sub>DDA</sub> = 1.8V	5	7.0		
		12.5MHz square wave (Note 2)	V <sub>DDA</sub> = 5V	8.2	10.0		
			V <sub>DDA</sub> = 3.3V	7.2	9.1		
			V <sub>DDA</sub> = 2.5V	6.7	8.7		
			V <sub>DDA</sub> = 1.8V	6.3	8.2		
		50MHz square wave (Note 2)	V <sub>DDA</sub> = 5V	18	23.3		
			V <sub>DDA</sub> = 3.3V	14.2	18.4		
			V <sub>DDA</sub> = 2.5V	12.3	16.1		
			V <sub>DDA</sub> = 1.8V	10.5	13.6		
	I <sub>DDB</sub>	500kHz square wave	V <sub>DDB</sub> = 5V	5.2	7.2		
			V <sub>DDB</sub> = 3.3V	5.2	7.2		
			V <sub>DDB</sub> = 2.5V	5.2	7.2		
			V <sub>DDB</sub> = 1.8V	5	7.0		
		12.5MHz square wave (Note 2)	V <sub>DDB</sub> = 5V	8.2	10.0		
			V <sub>DDB</sub> = 3.3V	7.2	9.1		
			V <sub>DDB</sub> = 2.5V	6.7	8.7		
			V <sub>DDB</sub> = 1.8V	6.3	8.2		
		50MHz square wave (Note 2)	V <sub>DDB</sub> = 5V	18	23.3		
			V <sub>DDB</sub> = 3.3V	14.2	18.4		
			V <sub>DDB</sub> = 2.5V	12.3	16.1		
			V <sub>DDB</sub> = 1.8V	10.5	13.6		

**DC Electrical Characteristics (continued)**

( $V_{DDA} - V_{GNDA} = +1.71V$  to  $+5.5V$ ,  $V_{DDB} - V_{GNDB} = +1.71V$  to  $+5.5V$ ,  $C_L = 15pF$ ,  $T_A = -40^{\circ}C$  to  $+125^{\circ}C$ , unless otherwise noted. Typical values are at  $V_{DDA} - V_{GNDA} = +3.3V$ ,  $V_{DDB} - V_{GNDB} = +3.3V$ ,  $V_{GNDA} = V_{GNDB}$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>LOGIC INPUTS AND OUTPUTS</b>						
Input High Voltage	$V_{IH}$	ENA, INA_ relative to GNDA	0.7 x $V_{DDA}$			V
		ENB, INB_ relative to GNDB	0.7 x $V_{DDB}$			
Input Low Voltage	$V_{IL}$	ENA, INA_ relative to GNDA	$1.71V \leq V_{DDA} \leq 1.89V$	0.6		V
			$2.25V \leq V_{DDA} \leq 5.5V$	0.8		
		ENB, INB_ relative to GNDB	$1.71V \leq V_{DDB} \leq 1.89V$	0.6		
			$2.25V \leq V_{DDB} \leq 5.5V$	0.8		
Input Hysteresis	$V_{HYS}$	$V_{INA\_}$ relative to GNDA or $V_{INB\_}$ relative to GNDB	MAX1493_A/D	410		mV
			MAX1493_B/E	410		
			MAX1493_C/F	80		
Input Leakage Current	$I_L$	$V_{INA\_} = 0$ or $V_{DDA}$ , $V_{INB\_} = 0$ or $V_{DDB}$	-1		+1	$\mu A$
Input Capacitance	$C_{IN}$	INA_, INB_, $f = 1MHz$		2		pF
EN_ Pullup Current	$I_{PU}$		-4	-2.3	-1	$\mu A$
Output Voltage High	$V_{OH}$	$V_{OUTA\_}$ relative to GNDA, $I_{OUTA\_} = -4mA$ (Note 3)	$V_{DDA} - 0.4$			V
		$V_{OUTB\_}$ relative to GNDB, $I_{OUTB\_} = -4mA$ (Note 3)	$V_{DDB} - 0.4$			
Output Voltage Low	$V_{OL}$	$V_{OUTA\_}$ relative to GNDA, $I_{OUTA\_} = 4mA$ (Note 3)	0.4			V
		$V_{OUTB\_}$ relative to GNDB, $I_{OUTB\_} = 4mA$ (Note 3)	0.4			

**Dynamic Electrical Characteristics (MAX1493\_A/D)**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>INPUT AND OUTPUT CHANNELS</b>						
Common-Mode Transient Immunity	CMTI	IN__ = GND_ or VDD_ (Note 4)		25		kV/μs
Maximum Data Rate	DR <sub>MAX</sub>		1			Mbps
Minimum Pulse Width	PW <sub>MIN</sub>	INA_ to OUTB_, INB_ to OUTA_			1	μs
Glitch Rejection		INA_ to OUTB_, INB_ to OUTA_		32		ns
Propagation Delay (Figure 1)	t <sub>PLH</sub>	INA_ to OUTB_, INB_ to OUTA_, C <sub>L</sub> = 15pF	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	38.2	54.1	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	38.7	54.6	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	39.7	55.6	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	42.9	58.4	
	t <sub>PHL</sub>	INA_ to OUTB_, INB_ to OUTA_, C <sub>L</sub> = 15pF	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	38.6	55.3	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	38.9	55.6	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	39.8	56.1	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	42.3	60.2	
Pulse-Width Distortion	PWD	t <sub>PLH</sub> - t <sub>PHL</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	0.4	4.5	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	0.2	4.3	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	0.1	3.9	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	0.6	4.7	
Propagation Delay Skew Part-to-Part (Same Channel)	t <sub>SPLH</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		26.6	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		26.6	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		26.6	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		26.9	
	t <sub>SPHL</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		27.9	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		27.7	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		27.6	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		29.7	
Propagation Delay Skew Channel-to-Channel (Same Direction)	t <sub>SCSLH</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		6.7	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		6.7	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		6.7	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		6.7	
	t <sub>SCSHL</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		6.7	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		6.7	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		6.7	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		6.7	

### Dynamic Electrical Characteristics (MAX1493\_A/D) (Continued)

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Propagation Delay Skew Channel-to-Channel (Opposing Direction)	t <sub>SCOLH</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			26.6	ns
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			26.6	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			26.6	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			26.9	
	t <sub>SCOHL</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			27.9	
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			27.7	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			27.6	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			29.7	
Rise Time (Figure 1)	t <sub>R</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		2	ns	
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		2		
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		2		
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		2		
Fall Time (Figure 1)	t <sub>F</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		2	ns	
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		2		
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		2		
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		2		
Enable to Data Valid	t <sub>EN</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			5.1	ns
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			5.5	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			6.7	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			16.3	
Enable to Three-State	t <sub>TRI</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			2.7	ns
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			4.4	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			7.0	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			11.7	



**Dynamic Electrical Characteristics (MAX1493\_B/E)**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>INPUT AND OUTPUT CHANNELS</b>						
Common-Mode Transient Immunity	CMTI	IN__ = GND_ or VDD_ (Note 4)		25		kV/μs
Maximum Data Rate	DR <sub>MAX</sub>		25			Mbps
Minimum Pulse Width	PW <sub>MIN</sub>	INA_ to OUTB_, INB_ to OUTA_			40	ns
Glitch Rejection		INA_ to OUTB_, INB_ to OUTA_		15		ns
Propagation Delay (Figure 1)	t <sub>PLH</sub>	INA_ to OUTB_, INB_ to OUTA_, C <sub>L</sub> = 15pF	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	20.9	27.5	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	21.4	28.7	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	22.4	31.2	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	25.7	36.9	
	t <sub>PHL</sub>	INA_ to OUTB_, INB_ to OUTA_, C <sub>L</sub> = 15pF	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	21.1	28.8	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	21.5	29.8	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	22.3	31.9	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	24.9	37.4	
Pulse-Width Distortion	PWD	t <sub>PLH</sub> - t <sub>PHL</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	0.2	2.6	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	0.1	2.6	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	0.1	2.4	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	0.7	3.2	
Propagation Delay Skew Part-to-Part (Same Channel)	t <sub>SPLH</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		11.7	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		11.5	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		11.3	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		13.6	
	t <sub>SPHL</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		9.8	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		9.8	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		11.1	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		14.4	
Propagation Delay Skew Channel-to-Channel (Same Direction)	t <sub>SCSLH</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		3	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		3	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		3	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		3	
	t <sub>SCSHL</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		3	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		3	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		3	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		3	

**Dynamic Electrical Characteristics (MAX1493\_B/E) (Continued)**

(V<sub>DDA</sub> - V<sub>GNDA</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GNDA</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GNDB</sub> = +3.3V, V<sub>GNDA</sub> = V<sub>GNDB</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Propagation Delay Skew Channel to Channel (Opposing Direction)	t <sub>SCOLH</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			11.7	ns
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			11.5	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			11.3	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			13.6	
	t <sub>SCOHL</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			9.8	
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			9.8	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			11.1	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			14.4	
Rise Time (Figure 1)	t <sub>R</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		2	ns	
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		2		
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		2		
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		2		
Fall Time (Figure 1)	t <sub>F</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		2	ns	
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		2		
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		2		
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		2		
Enable to Data Valid	t <sub>EN</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			5.1	ns
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			5.5	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			6.7	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			16.3	
Enable to Three-State	t <sub>TRI</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V			2.7	ns
		3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V			4.4	
		2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V			7.0	
		1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V			11.7	

**Dynamic Electrical Characteristics (MAX1493\_C/F)**

(V<sub>DDA</sub> - V<sub>GND A</sub> = +1.71V to +5.5V, V<sub>DDB</sub> - V<sub>GND B</sub> = +1.71V to +5.5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = -40°C to +125°C, unless otherwise noted. Typical values are at V<sub>DDA</sub> - V<sub>GND A</sub> = +3.3V, V<sub>DDB</sub> - V<sub>GND B</sub> = +3.3V, V<sub>GND A</sub> = V<sub>GND B</sub>, T<sub>A</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
<b>INPUT AND OUTPUT CHANNELS</b>						
Common-Mode Transient Immunity	CMTI	IN <sub>__</sub> = GND <sub>__</sub> or V <sub>DD</sub> <sub>__</sub> (Note 4)		25		kV/μs
Maximum Data Rate	DR <sub>MAX</sub>		150			Mbps
Minimum Pulse Width	PW <sub>MIN</sub>	INA <sub>__</sub> to OUTB <sub>__</sub> , INB <sub>__</sub> to OUTB <sub>__</sub>			6.67	ns
Propagation Delay (Figure 1)	t <sub>PLH</sub>	INA <sub>__</sub> to OUTB <sub>__</sub> , INB <sub>__</sub> to OUTA <sub>__</sub> , C <sub>L</sub> = 15pF	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	5.1	7.5	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	5.2	8.1	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	5.8	9.7	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	8.1	14	
	t <sub>PHL</sub>	INA <sub>__</sub> to OUTB <sub>__</sub> , INB <sub>__</sub> to OUTA <sub>__</sub> , C <sub>L</sub> = 15pF	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	4.9	7.4	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	5.3	8.3	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	5.9	10.2	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	8.2	14.9	
Pulse-Width Distortion	PWD	t <sub>PLH</sub> - t <sub>PHL</sub>	4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V	0.2	1	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V	0.1	1	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V	0.1	1	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V	0.1	1	
Propagation Delay Skew Part-to-Part (Same Channel)	t <sub>SPLH</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		3.0	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		3.3	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		4.3	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		7.1	
	t <sub>SPHL</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		2.8	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		3.4	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		4.6	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		7.9	
Propagation Delay Skew Channel-to-Channel (Same Direction)	t <sub>SCSLH</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		0.9	ns
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		1.2	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		1.4	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		1.6	
	t <sub>SCSHL</sub>		4.5V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 5.5V		0.9	
			3.0V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 3.6V		1.2	
			2.25V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 2.75V		1.4	
			1.71V ≤ V <sub>DDA</sub> , V <sub>DDB</sub> ≤ 1.89V		1.6	

**Dynamic Electrical Characteristics (MAX1493\_C/F) (continued)**

( $V_{DDA} - V_{GNDA} = +1.71V$  to  $+5.5V$ ,  $V_{DDB} - V_{GNDB} = +1.71V$  to  $+5.5V$ ,  $C_L = 15pF$ ,  $T_A = -40^\circ C$  to  $+125^\circ C$ , unless otherwise noted. Typical values are at  $V_{DDA} - V_{GNDA} = +3.3V$ ,  $V_{DDB} - V_{GNDB} = +3.3V$ ,  $V_{GNDA} = V_{GNDB}$ ,  $T_A = +25^\circ C$ , unless otherwise noted.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Propagation Delay Skew Channel-to-Channel (Opposing Direction)	$t_{SCOLH}$	$4.5V \leq V_{DDA}$ , $V_{DDB} \leq 5.5V$			3	ns
		$3.0V \leq V_{DDA}$ , $V_{DDB} \leq 3.6V$			3.3	
		$2.25V \leq V_{DDA}$ , $V_{DDB} \leq 2.75V$			4.3	
		$1.71V \leq V_{DDA}$ , $V_{DDB} \leq 1.89V$			7.1	
	$t_{SCOHL}$	$4.5V \leq V_{DDA}$ , $V_{DDB} \leq 5.5V$			2.8	
		$3.0V \leq V_{DDA}$ , $V_{DDB} \leq 3.6V$			3.4	
		$2.25V \leq V_{DDA}$ , $V_{DDB} \leq 2.75V$			4.6	
		$1.71V \leq V_{DDA}$ , $V_{DDB} \leq 1.89V$			7.9	
Rise Time (Figure 1)	$t_R$	$OUTA\_ /$ $OUTB\_ ,$ 10% to 90%, $C_L = 15pF$	$4.5V \leq V_{DDA}$ , $V_{DDB} \leq 5.5V$		2	ns
		$3.0V \leq V_{DDA}$ , $V_{DDB} \leq 3.6V$		2		
		$2.25V \leq V_{DDA}$ , $V_{DDB} \leq 2.75V$		2		
		$1.71V \leq V_{DDA}$ , $V_{DDB} \leq 1.89V$		2		
Fall Time (Figure 1)	$t_F$	$OUTA\_ /$ $OUTB\_ ,$ 90% to 10%, $C_L = 15pF$	$4.5V \leq V_{DDA}$ , $V_{DDB} \leq 5.5V$		2	ns
		$3.0V \leq V_{DDA}$ , $V_{DDB} \leq 3.6V$		2		
		$2.25V \leq V_{DDA}$ , $V_{DDB} \leq 2.75V$		2		
		$1.71V \leq V_{DDA}$ , $V_{DDB} \leq 1.89V$		2		
Enable to Data Valid	$t_{EN}$	$ENA$ to $OUTA\_ ,$ $ENB$ to $OUTB\_ ,$ $C_L = 15pF$	$4.5V \leq V_{DDA}$ , $V_{DDB} \leq 5.5V$		5.1	ns
		$3.0V \leq V_{DDA}$ , $V_{DDB} \leq 3.6V$		5.5		
		$2.25V \leq V_{DDA}$ , $V_{DDB} \leq 2.75V$		6.7		
		$1.71V \leq V_{DDA}$ , $V_{DDB} \leq 1.89V$		16.3		
Enable to Three-State	$t_{TRI}$	$ENA$ to $OUTA\_ ,$ $ENB$ to $OUTB\_ ,$ $C_L = 15pF$	$4.5V \leq V_{DDA}$ , $V_{DDB} \leq 5.5V$		2.7	ns
		$3.0V \leq V_{DDA}$ , $V_{DDB} \leq 3.6V$		4.4		
		$2.25V \leq V_{DDA}$ , $V_{DDB} \leq 2.75V$		7.0		
		$V_{DDA}$ , $V_{DDB} \leq 1.89V$		11.7		
Peak Eye Diagram Jitter	$T_{JIT(PK)}$	$V_{DDA}$ , $V_{DDB} = 5.0V$			140	ps
		$V_{DDA}$ , $V_{DDB} = 3.3V$			130	
		$V_{DDA}$ , $V_{DDB} = 2.5V$			140	
		$V_{DDA}$ , $V_{DDB} = 1.8V$			160	

**ESD Protection**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ESD		Human Body Model, All Pins		±4		kV

- Note 1:** All devices are 100% production tested at T<sub>A</sub> = +125°C. Specifications over temperature are guaranteed by design.
- Note 2:** Not production tested. Guaranteed by design.
- Note 3:** All currents into the device are positive. All currents out of the device are negative.
- Note 4:** CMTI is the maximum sustainable common-mode voltage slew rate while maintaining the correct output. CMTI applies to both rising and falling common-mode voltage edges. Tested with the transient generator connected between GNDA and GNDB (V<sub>CM</sub> = 1000V).

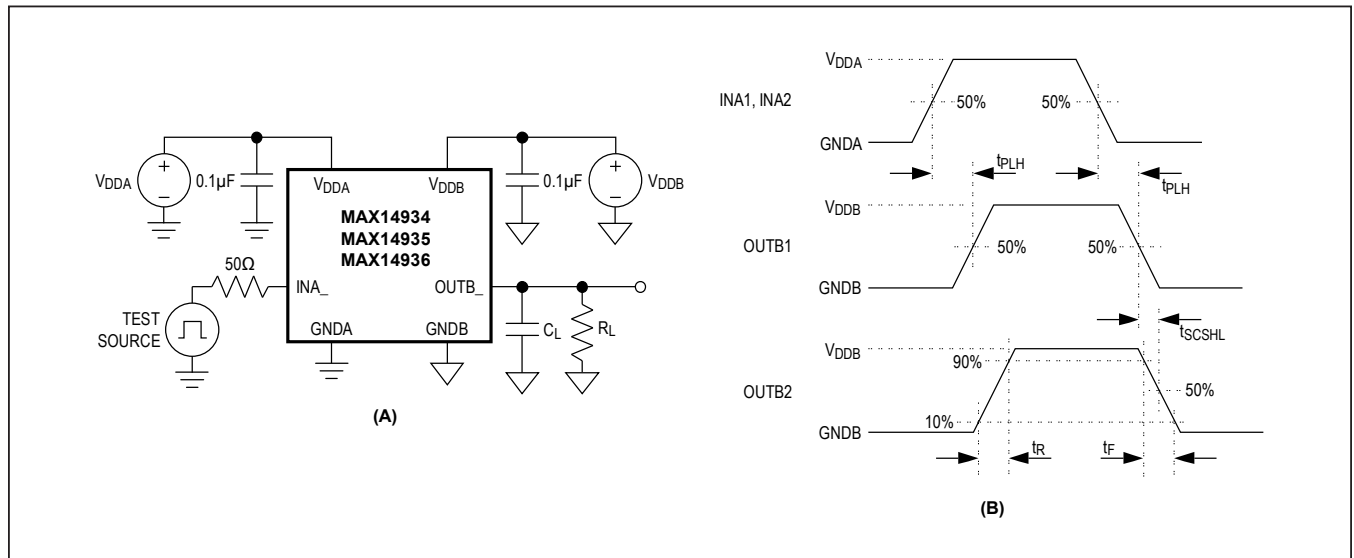


Figure 1. Test Circuit (A) and Timing Diagram (B)

**Safety Regulatory Approvals**

<b>UL</b>
The MAX14934–MAX14936 are certified under UL1577. For more details, refer to File E351759.
Rated up to 5000V <sub>RMS</sub> isolation voltage for single protection.
<b>cUL (Equivalent to CSA notice 5A)</b>
The MAX14934-MAX14936 are certified up to 5000V <sub>RMS</sub> for single protection. For more details, refer to File E351759.
<b>VDE</b>
The MAX14934-MAX14936 are certified to DIN VDE V 0884-11: 2017-01. For details, see file ref. 5015017-4880-0001/272147/TL7/ SCT. Basic Insulation, Maximum Transient Isolation Voltage 8400V <sub>PK</sub> , Maximum Repetitive Peak Isolation Voltage 1200V <sub>PK</sub>

*This coupler is suitable for “safe electrical insulation” only within the safety ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.*

## IEC Insulation Testing

TUV
The MAX14934-MAX14936 are tested under TUV.
IEC 60950-1: Up to 1200V <sub>PK</sub> (848V <sub>RMS</sub> ) working voltage for basic insulation.
IEC 61010-1 (ed. 3): Up to 848V <sub>RMS</sub> working voltage for basic insulation. For details, see Technical Report number 095-72100581-100.
IEC 60601-1 (ed. 3): For details see Technical Report number 095-72100581-200.
Basic insulation 1 MOOP, 1200V <sub>PK</sub> (848V <sub>RMS</sub> )
Withstand isolation voltage (V <sub>ISO</sub> ) for 60s, 5000V <sub>RMS</sub>

## MAX14934–MAX14936 Insulation Characteristics

PARAMETER	SYMBOL	CONDITIONS	VALUE	UNITS
Partial Discharge Test Voltage	V <sub>PR</sub>	Method B1 = V <sub>IORM</sub> × 1.875 (t = 1s, partial discharge < 5pC)	2250	V <sub>P</sub>
Maximum Repetitive Peak Isolation Voltage	V <sub>IORM</sub>	(Note 5)	1200	V <sub>P</sub>
Maximum Working Isolation Voltage	V <sub>IOWM</sub>	Continuous RMS voltage (Note 5)	848	V <sub>RMS</sub>
Maximum Transient Isolation Voltage	V <sub>IOTM</sub>	t = 1s (Note 5)	8400	V <sub>P</sub>
Maximum Withstand Isolation Voltage	V <sub>ISO</sub>	f <sub>SW</sub> = 60Hz, duration = 60s (Note 5, 6)	5000	V <sub>RMS</sub>
Maximum Surge Isolation Voltage	V <sub>IOSM</sub>	Basic insulation, 1.2/50μs pulse per IEC 61000-4-5 (Note 5, 7)	10	kV
Insulation Resistance	R <sub>IO</sub>	V <sub>IO</sub> = 500V, T <sub>A</sub> = 25°C	> 10 <sup>12</sup>	Ω
		V <sub>IO</sub> = 500V, 100°C ≤ T <sub>A</sub> ≤ 125°C	> 10 <sup>11</sup>	
		V <sub>IO</sub> = 500V at T <sub>S</sub> = 150°C	> 10 <sup>9</sup>	
Barrier Capacitance Side A to Side B	C <sub>IO</sub>	f <sub>SW</sub> = 1MHz (Note 8)	2	pF
Minimum Creepage Distance	CPG	Wide SOIC	8	mm
Minimum Clearance Distance	CLR	Wide SOIC	8	mm
Internal Clearance		Distance through insulation	0.015	mm
Comparative Tracking Index	CTI	Material Group II (IEC 60112)	575	
Climatic Category			40/125/21	
Pollution Degree (DIN VDE 0110, Table 1)			2	

**Note 5:** V<sub>ISO</sub>, V<sub>IOTM</sub>, V<sub>IOSM</sub>, V<sub>IOWM</sub>, and V<sub>IORM</sub> are defined by the IEC 60747-5-5 standard.

**Note 6:** Products are qualified at V<sub>ISO</sub> for 60s and 100% production tested at 120% of V<sub>ISO</sub> for 1s.

**Note 7:** Devices are immersed in oil during surge characterization.

**Note 8:** Capacitance is measured with all pins on field-side and logic-side tied together.

**Safety Limits**

Damage to the IC can result in a low-resistance path to ground or to the supply and, without current limiting, the MAX14934–MAX14936 could dissipate excessive amounts of power. Excessive power dissipation can damage the die and result in damage to the isolation barrier, potentially causing downstream issues. [Table 1](#) shows the safety limits for the MAX14934–MAX14936.

The maximum safety temperature (T<sub>S</sub>) for the device is the 150°C maximum junction temperature specified in the [Absolute Maximum Ratings](#). The power dissipation (P<sub>D</sub>) and junction-to-ambient thermal impedance (θ<sub>JA</sub>)

determine the junction temperature. Thermal impedance values (θ<sub>JA</sub> and θ<sub>JC</sub>) are available in the [Package Information](#) section of the datasheet. Calculate the junction temperature (T<sub>J</sub>) as:

$$T_J = T_A + (P_D \times \theta_{JA})$$

[Figure 2](#) to [Figure 3](#) show the thermal derating curves for the safety power limiting and safety current limiting of the devices. Ensure that the junction temperature does not exceed 150°C.

**Table 1. Safety Limiting Values for the MAX14934–MAX14936**

PARAMETER	SYMBOL	TEST CONDITIONS	MAX	UNITS
Safety Current on Any Pin (No Damage to Isolation Barrier)	I <sub>S</sub>	T <sub>J</sub> = 150°C, T <sub>A</sub> = 25°C	300	mA
Total Safety Power Dissipation	P <sub>S</sub>	T <sub>J</sub> = 150°C, T <sub>A</sub> = 25°C	1760	mW
Maximum Safety Temperature	T <sub>S</sub>		150	°C

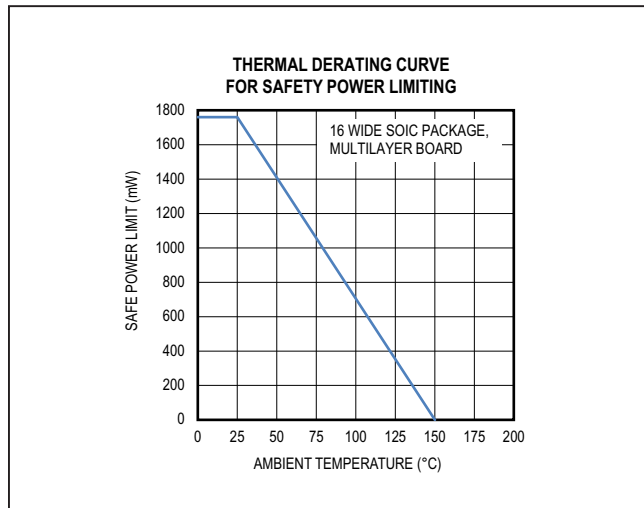


Figure 2. Thermal Derating Curve for Safety Power Limiting

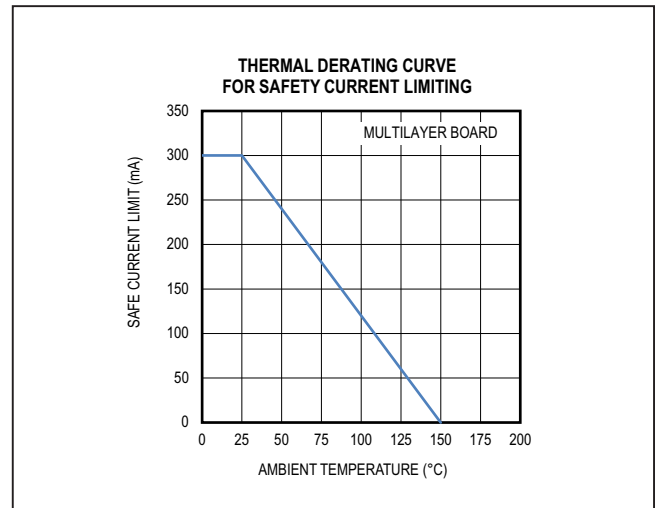
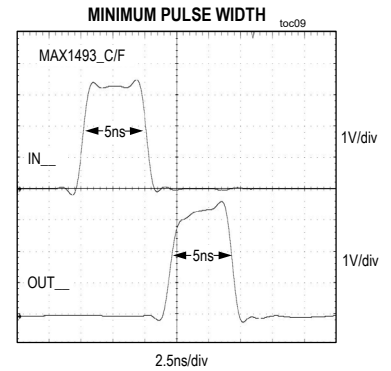
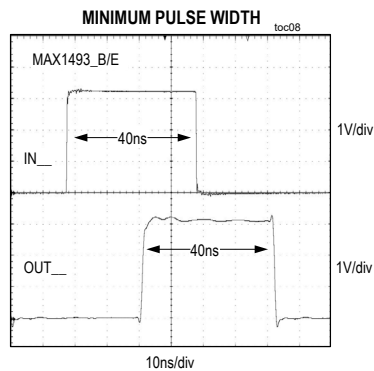
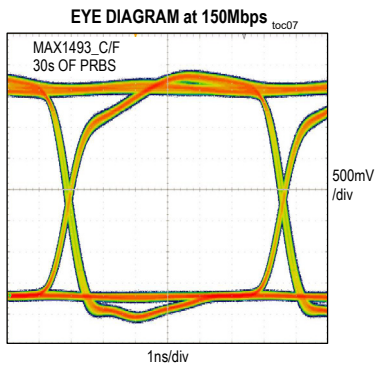
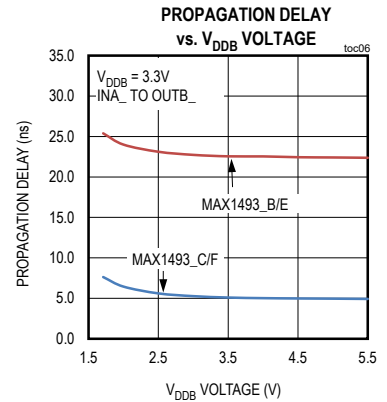
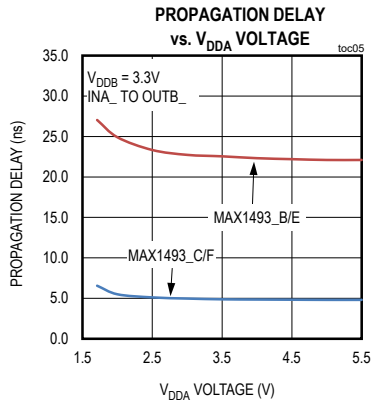
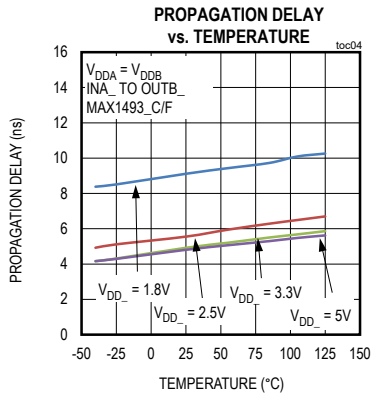
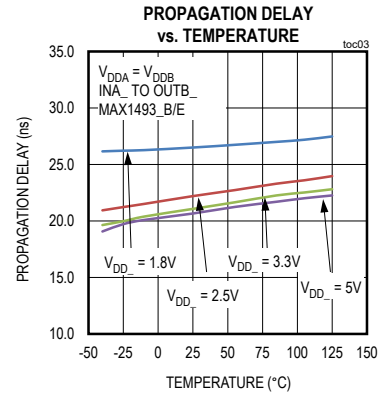
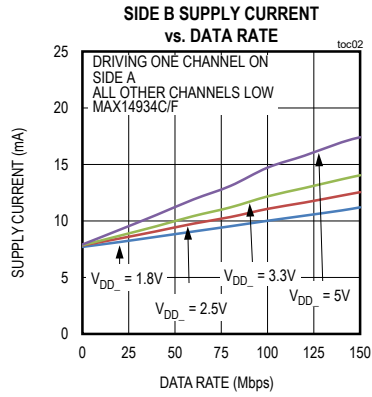
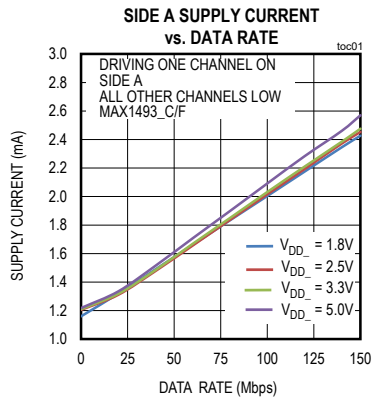


Figure 3. Thermal Derating Curve for Safety Current Limiting

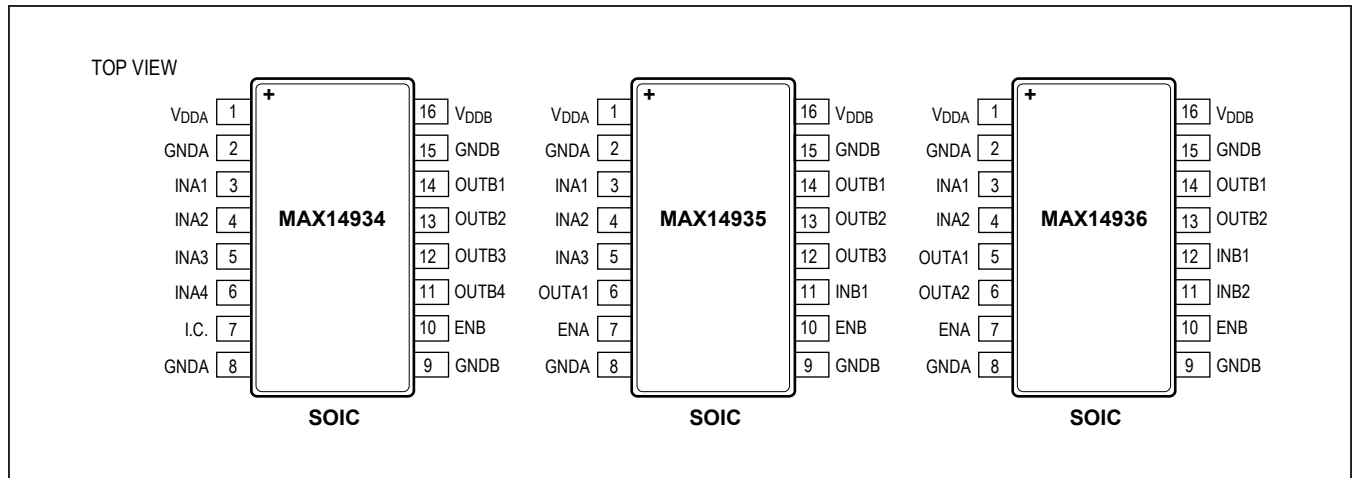
Typical Operating Characteristics

( $V_{DDA} - V_{GNDA} = +3.3V$ ,  $V_{DDB} - V_{GNDB} = +3.3V$ ,  $V_{GNDA} = V_{GNDB}$ ,  $T_A = +25^\circ C$ , unless otherwise noted.)





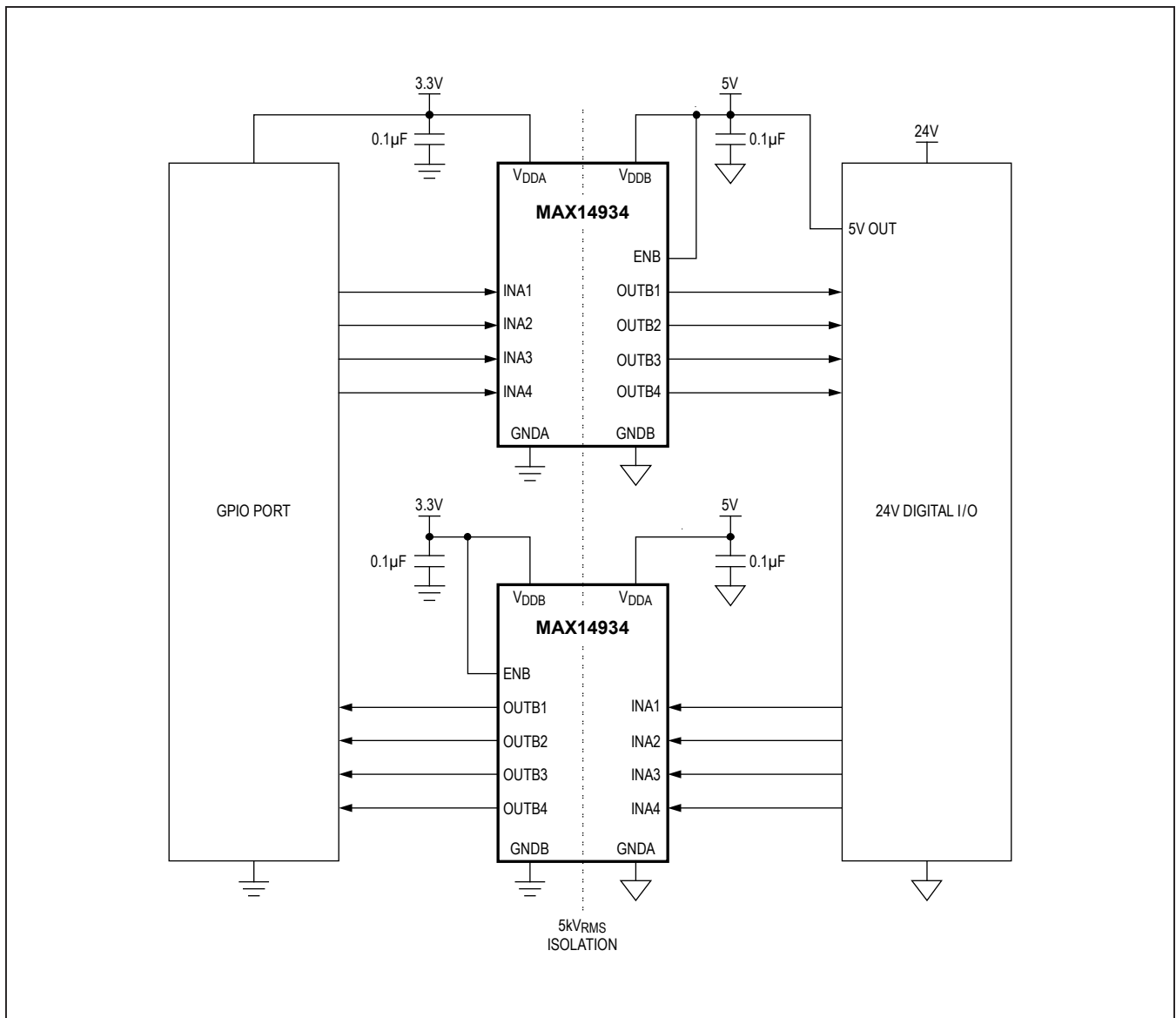
Pin Configurations



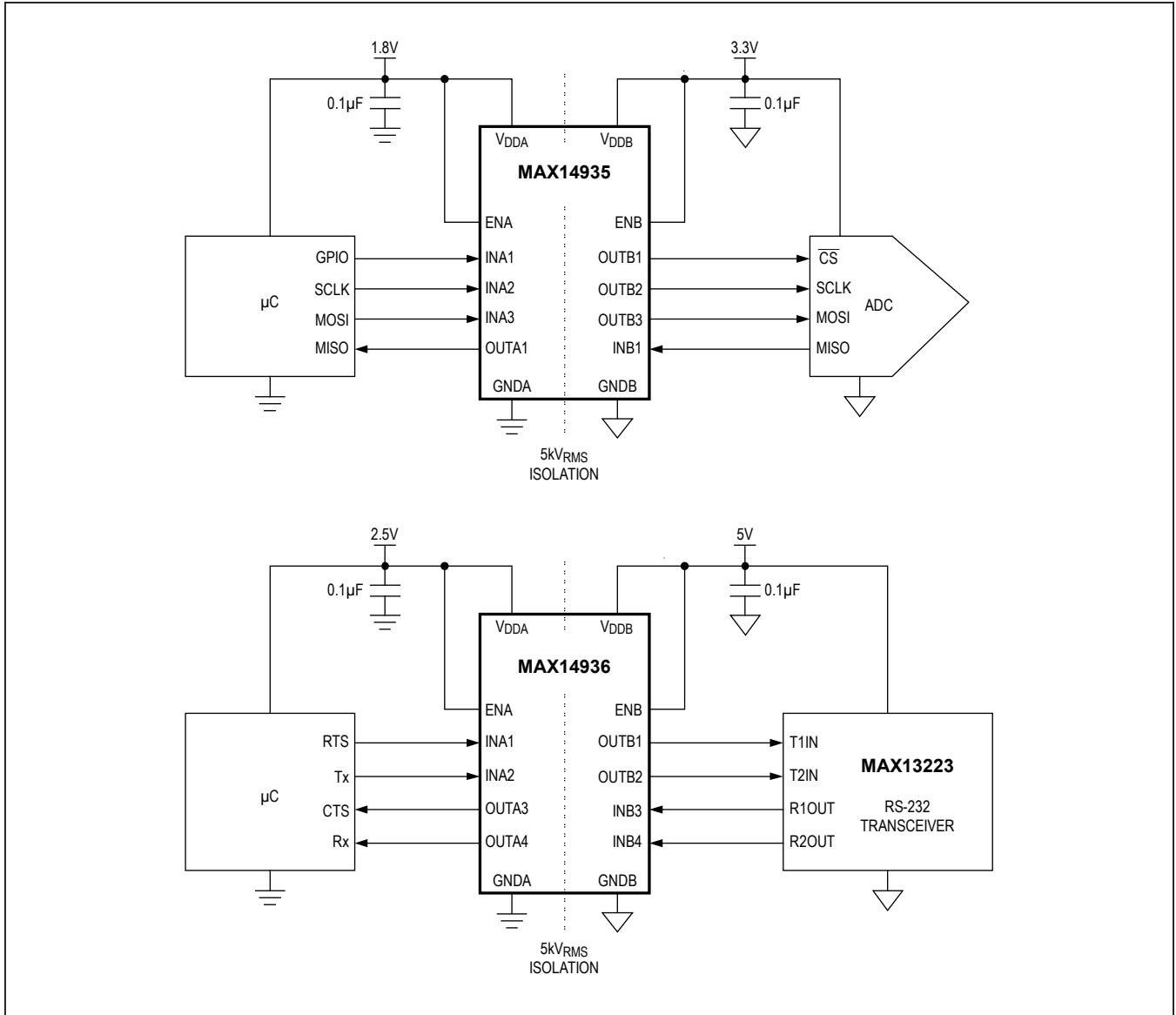
Pin Description

PIN			NAME	FUNCTION	VOLTAGE RELATIVE TO
MAX14934	MAX14935	MAX14936			
1	1	1	V <sub>DDA</sub>	Power Supply. Bypass V <sub>DDA</sub> with a 0.1µF ceramic capacitor as close as possible to the pin.	GNDA
2, 8	2, 8	2, 8	GNDA	Ground Reference for Side A	—
3	3	3	INA1	Logic Input 1 on Side A. INA1 corresponds to OUTB1.	GNDA
4	4	4	INA2	Logic Input 2 on Side A. INA2 corresponds to OUTB2.	GNDA
5	5	—	INA3	Logic Input 3 on Side A. INA3 corresponds to OUTB3.	GNDA
6	—	—	INA4	Logic Input 4 on Side A. INA4 corresponds to OUTB4.	GNDA
7	—	—	I.C.	Internally Connected. Leave unconnected or connect to GNDA or V <sub>DDA</sub> .	—
—	6	5	OUTA1	Logic Output 1 on Side A	GNDA
—	—	6	OUTA2	Logic Output 2 on Side A	GNDA
—	7	7	ENA	Active-High Enable for Side A. ENA has an internal 2µA pullup to V <sub>DDA</sub> .	GNDA
9, 15	9, 15	9, 15	GNDB	Ground Reference for Side B	—
10	10	10	ENB	Active-High Enable for Side B. ENB has an internal 2µA pullup to V <sub>DDB</sub> .	GNDB
11	—	—	OUTB4	Logic Output 4 on Side B	GNDB
—	11	12	INB1	Logic Input 1 on Side B. INB1 corresponds to OUTA1.	GNDB
—	—	11	INB2	Logic Input 2 on Side B. INB2 corresponds to OUTA2.	GNDB
12	12	—	OUTB3	Logic Output 3 on Side B	GNDB
13	13	13	OUTB2	Logic Output 2 on Side B	GNDB
14	14	14	OUTB1	Logic Output 1 on Side B	GNDB
16	16	16	V <sub>DDB</sub>	Power Supply. Bypass V <sub>DDB</sub> with a 0.1µF ceramic capacitor as close as possible to the pin.	GNDB

Typical Application Circuits



Typical Application Circuits (continued)



## Detailed Description

The MAX14934–MAX14936 are a family of four-channel digital isolators. The MAX14934–MAX14936 family transfers digital signals between circuits with different power domains. The devices are rated for 5kV<sub>RMS</sub> isolation voltage for 60 seconds. This family of digital isolators offers low-power operation, high electromagnetic interference (EMI) immunity, and stable temperature performance through Maxim's proprietary process technology. The devices isolate different ground domains and block high-voltage/high-current transients from sensitive or human interface circuitry.

The MAX14934–MAX14936 family offers three unidirectional channel configurations for design convenience. The MAX14934 features four channels transferring digital signals in one direction for applications such as isolated digital I/O. The MAX14935 has three channels transmitting data in one direction and one channel transmitting in the opposite direction, making it ideal for applications such as isolated SPI and RS-485 communication. The MAX14936 provides further design flexibility with two channels in each direction for isolated RS-232 or other applications.

Devices are available with data rates from DC up to 1Mbps (A/D versions), 25Mbps (B/E versions), or 150Mbps (C/F versions). Each device can also be ordered with default-high or default-low outputs. This is the state an output will go to when the input side of the device is unpowered.

The devices have two supply inputs, V<sub>DDA</sub> and V<sub>DDB</sub>, that independently set the logic levels on either side of the device. V<sub>DDA</sub> and V<sub>DDB</sub> are referenced to GNDA and GNDB, respectively. The MAX14934–MAX14936 family also features a refresh circuit to ensure output accuracy when an input remains in the same state indefinitely.

### Digital Isolation

The MAX14934–MAX14936 family provides galvanic isolation for digital signals that are transmitted between two ground domains. Up to 1200V<sub>PEAK</sub> of continuous isolation is supported, as well as transient differences of up to 5kV<sub>RMS</sub> for up to 60 seconds.

### Level Shifting

The wide supply voltage range of both V<sub>DDA</sub> and V<sub>DDB</sub> allows the MAX14934–MAX14936 family to be used for level translation in addition to isolation. V<sub>DDA</sub> and V<sub>DDB</sub> can be independently set to any voltage from 1.71V to 5.5V. The supply voltage sets the logic level on the corresponding side of the isolator.

## Unidirectional Channels

Each channel of the MAX14934–MAX14936 is unidirectional; it only passes data in one direction, as indicated in the functional diagram. Each device features four unidirectional channels that operate independently with guaranteed data rates from DC up to 1Mbps (A/D versions), 25Mbps (B/E versions), or 150Mbps (C/F versions). The output driver of each channel is push-pull, eliminating the need for pullup resistors. The outputs are able to drive both TTL and CMOS logic inputs.

## Startup and Undervoltage Lockout

The V<sub>DDA</sub> and V<sub>DDB</sub> supplies are both internally monitored for undervoltage conditions. Undervoltage events can occur during power-up, power-down, or during normal operation due to a sagging supply voltage. When an undervoltage condition is detected on either supply, all outputs go to their default states regardless of the status of the inputs (Table 2). Figure 4 through Figure 7 show the behavior of the outputs during power-up and power-down.

## Applications Information

### Power-Supply Sequencing

The MAX14934–MAX14936 do not require special power-supply sequencing. The logic levels are set independently on either side by V<sub>DDA</sub> and V<sub>DDB</sub>. Each supply can be present over the entire specified range regardless of the level or presence of the other supply.

### Power-Supply Decoupling

To reduce ripple and the chance of introducing data errors, bypass V<sub>DDA</sub> and V<sub>DDB</sub> with 0.1μF ceramic capacitors to GNDA and GNDB, respectively. Place the bypass capacitors as close to the power-supply input pins as possible.

### Layout Considerations

The PCB designer should follow some critical recommendations in order to get the best performance from the design.

- Keep the input/output traces as short as possible. To keep signal paths low-inductance, avoid using vias.
- Have a solid ground plane underneath the high-speed signal layer.
- Keep the area underneath the MAX14934–MAX14936 free from ground and signal planes. Any galvanic or metallic connection between the Side A and Side B defeats the isolation.

**Table 2. Output Behavior During Undervoltage Conditions**

V <sub>IN</sub>	V <sub>DDA</sub>	V <sub>DDB</sub>	ENA	ENB	V <sub>OUTA</sub>	V <sub>OUTB</sub>
1	Powered	Powered	1	1	1	1
			0	0	Hi-Z	Hi-Z
0	Powered	Powered	1	1	0	0
			0	0	Hi-Z	Hi-Z
X	Undervoltage	Powered	1	1	Default	Default
			0	0	Hi-Z	Hi-Z
X	Powered	Undervoltage	1	1	Default	Default
			0	0	Hi-Z	Hi-Z

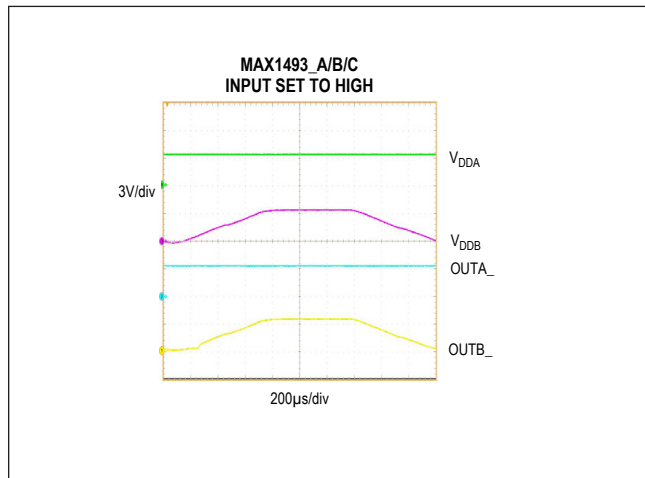


Figure 4. Undervoltage Lockout Behavior (MAX1493\_A/B/C High)

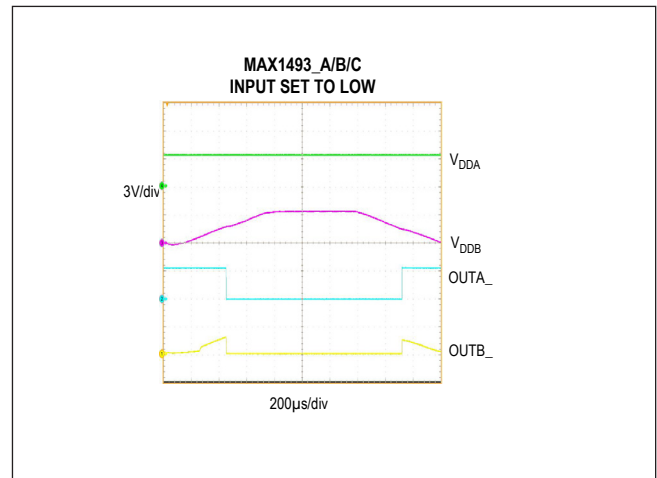


Figure 5. Undervoltage Lockout Behavior (MAX1493\_A/B/C Low)

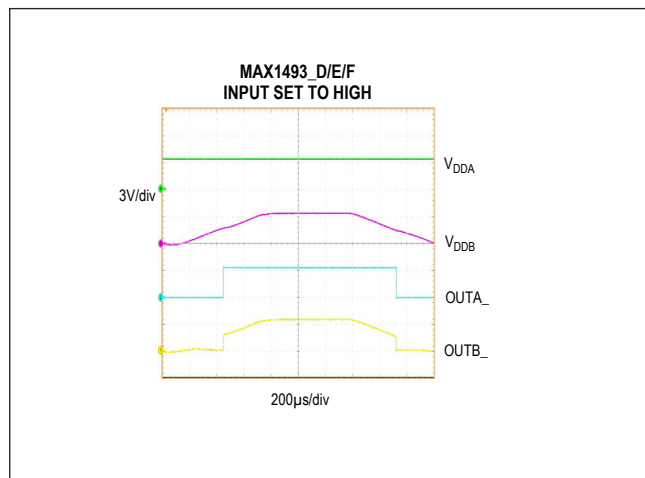


Figure 6. Undervoltage Lockout Behavior (MAX1493\_D/E/F High)

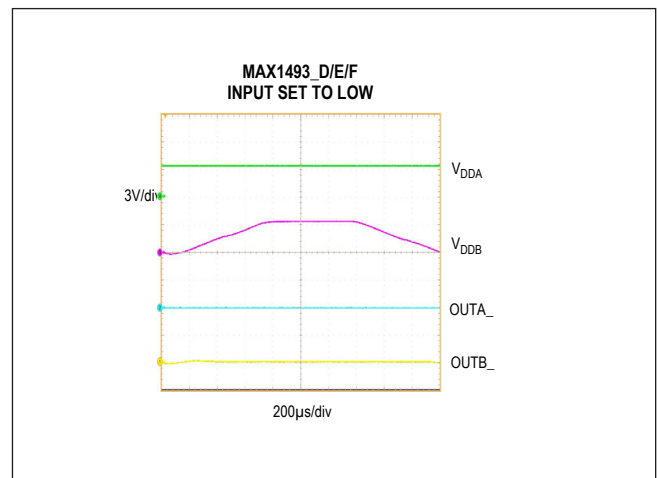


Figure 7. Undervoltage Lockout Behavior (MAX1493\_D/E/F Low)

Product Selector Guide

MAX14934 F A W E +

CHANNEL CONFIGURATION  
4: 4/0  
5: 3/1  
6: 2/2

MAXIMUM DATA RATE  
DEFAULT OUTPUT  
(SEE TABLE)

TEMP RANGE: -40°C TO +125°C

PACKAGE: W SOIC

PINS: 16

LEAD-FREE/ROHS COMPLIANT

DEVICE CONFIGURATION	MAX DATA RATE		
	1Mbps	25Mbps	150Mbps
DEFAULT-HIGH OUTPUT	A	B	C
DEFAULT-LOW OUTPUT	D	E	F

Ordering Information

PART	CHANNEL CONFIGURATION	DATA RATE (Mbps)	OUTPUT	TEMP RANGE (°C)	PIN-PACKAGE
MAX14934AAWE+	4/0	1	Default high	-40 to +125	16 wide SOIC
MAX14934BAWE+	4/0	25	Default high	-40 to +125	16 wide SOIC
MAX14934CAWE+	4/0	150	Default high	-40 to +125	16 wide SOIC
MAX14934DAWE+	4/0	1	Default low	-40 to +125	16 wide SOIC
MAX14934EAW+	4/0	25	Default low	-40 to +125	16 wide SOIC
MAX14934FAWE+	4/0	150	Default low	-40 to +125	16 wide SOIC
MAX14935AAWE+	3/1	1	Default high	-40 to +125	16 wide SOIC
MAX14935BAWE+	3/1	25	Default high	-40 to +125	16 wide SOIC
MAX14935CAWE+	3/1	150	Default high	-40 to +125	16 wide SOIC
MAX14935DAWE+	3/1	1	Default low	-40 to +125	16 wide SOIC
MAX14935EAW+	3/1	25	Default low	-40 to +125	16 wide SOIC
MAX14935FAWE+	3/1	150	Default low	-40 to +125	16 wide SOIC
MAX14936AAWE+	2/2	1	Default high	-40 to +125	16 wide SOIC
MAX14936BAWE+	2/2	25	Default high	-40 to +125	16 wide SOIC
MAX14936CAWE+	2/2	150	Default high	-40 to +125	16 wide SOIC
MAX14936DAWE+	2/2	1	Default low	-40 to +125	16 wide SOIC
MAX14936EAW+	2/2	25	Default low	-40 to +125	16 wide SOIC
MAX14936FAWE+	2/2	150	Default low	-40 to +125	16 wide SOIC

+Denotes a lead(Pb)-free/RoHS-compliant package.

Chip Information

PROCESS: BiCMOS